

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Daniel J. Pugh	01/24/2006
Herman Schmit	01/24/2006
Jason Redgrave	01/24/2006
Andrew Caldwell	01/26/2006
RECEIVING PARTY DATA	
Name:	Tabula, Inc.
Street Address:	3250 Olcott Street
City:	Santa Clara
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11269518
CORRESPONDENCE DATA	
Fax Number:	(310)785-9558
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	(310) 785-0140 x301
Email:	mani@sjalaw.com
Correspondent Name:	Mani Adeli
Address Line 1:	1875 Century Park East
Address Line 2:	Suite 1360
Address Line 4:	Los Angeles, CALIFORNIA 90067
ATTORNEY DOCKET NUMBER:	TBUL.P0064
NAME OF SUBMITTER:	Mani Adeli

OP \$40.00 11269518

500082233

PATENT
REEL: 017243 FRAME: 0686

Total Attachments: 3

source=TBUL.P0064 - Assignment Page 1#page1.tif

source=TBUL.P0064 - Assignment Page 2#page1.tif

source=TBUL.P0064 - Assignment Page 3#page1.tif

PATENT

REEL: 017243 FRAME: 0687

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of:

Daniel J. Pugh, et al.

Serial No.: 11/269,518

Filing Date: 11/07/2005

For: USE OF HYBRID
INTERCONNECT/LOGIC CIRCUITS
FOR MULTIPLICATION

JOINT INVENTORS TO CORPORATION ASSIGNMENT

WHEREAS, the undersigned Inventors have invented certain new and useful improvements in:

USE OF HYBRID INTERCONNECT/LOGIC CIRCUITS FOR MULTIPLICATION

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

- ☒ Said application having Serial Number 11/269,518 and filed on November 07, 2005.

WHEREAS Tabula, Inc. (hereinafter termed "Assignee"), a corporation of the State of Delaware, having a place of business at 3250 Olcott Street, Santa Clara, CA 95054, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by each of said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey to said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any or all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any

of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

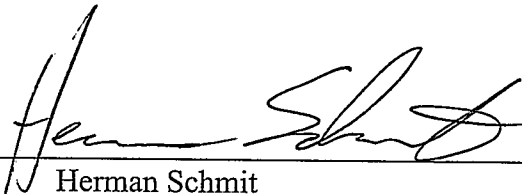
2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefore and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.


3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives, and assigns.


4. Said Inventors hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventors have executed this instrument on the date of acknowledgement as given below and delivered this instrument to said Assignee.

(1)  Date: 1/29/06
Daniel J. Pugh

(2)  Date: 1/24/06
Herman Schmit

(3)  Date: 1/24/06
Jason Redgrave

(3)  Date: 1/26/2006
Andrew Caldwell
